MTA2V

Automotive high current molded through-hole power inductor

Photo is representative

Product features

- AEC-Q200
- Shielded construction
- Ideal for high transient current spikes without saturation
- Ultra low buzz noise due to composite construction
- Isolation voltage, coil to core:
  500 Vac, 60 s, 1 mA maximum
- Termination finish: tin dipped
- Core material: Alloy powder

Applications

- Infotainment and cluster electronics
- Audio subsystem: head unit and trunk amp
- Digital instrument cluster
- Electronic stability control system (ESC)
- Engine and Powertrain systems
- Electric pumps, motor control and auxiliaries
- Powertrain control unit (PCU)/Engine control unit (ECU)
- Transmission control unit (TCU)
- LED lighting
- Heating ventilation and air conditioning controllers (HVAC)
- High current and high temperature applications
- DC/DC converters
- High current motor and switching noise suppression
- Inverters

Environmental compliance and general specifications

- Storage temperature (packaging):
  +5 °C to +40 °C, R.H.: 10% to 80%
- Storage temperature (component):
  -40 °C to +125 °C, R.H. :10% to 80%
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)

Pb RoHS

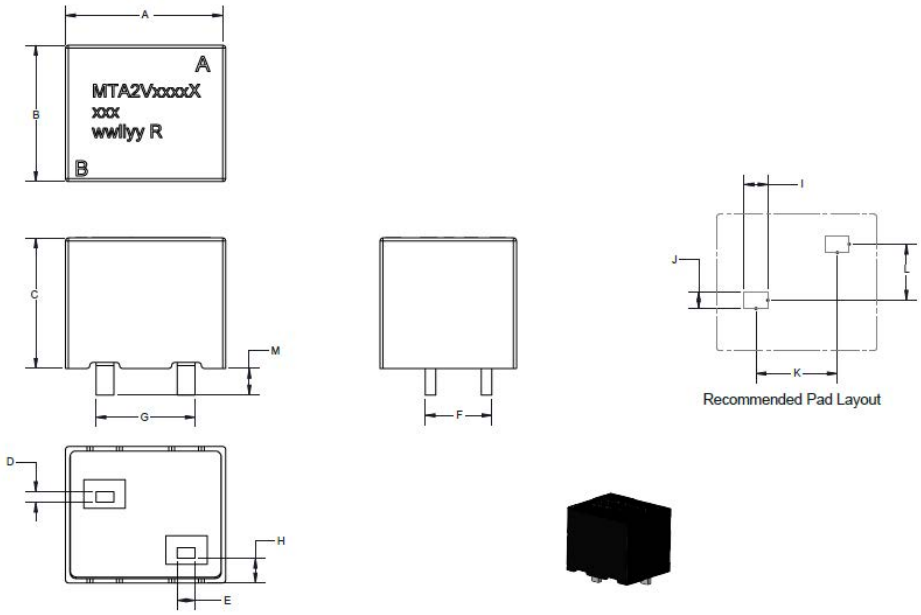
Product specifications

Part number[9]	OCL[1] (µH) ±20%	FLL[2] (µH) minimum	I_{rms1}[3] (A)	I_{rms2}[4] (A)	I_{sat1}[5] (A)	I_{sat2}[6] (A)	DCR (mΩ) typical @ +25 °C	DCR (mΩ) maximum @ +25 °C	SRF[7] (MHz) typical	K-factor[8]
MTA2V2722L-2R2-R	2.2	1.41	57	66	70	90	0.72	0.83	28.8	21.28
MTA2V2722L-3R5-R	3.5	2.24	57	66	50	65	0.72	0.83	25.5	21.28
MTA2V2726H-3R3-R	3.3	2.11	67	76	100	128	0.63	0.72	22.3	17.00
MTA2V2726H-6R8-R	6.8	4.35	55.5	63	60	78	0.86	0.95	13.4	13.84
MTA2V2726L-3R3-R	3.3	2.11	67	76	75	100	0.63	0.72	23.4	17.00
MTA2V2726L-130-R	13	8.32	38	44	37	47	1.95	2.25	9.5	9.19
MTA2V2726M-4R7-R	4.7	3.01	55.5	63	85	115	0.86	0.95	16.6	16.85
MTA2V3029L-2R2-R	2.2	1.41	85	97	95	125	0.32	0.37	25.5	18.11
MTA2V3029L-3R0-R	3.0	1.92	85	97	79	102	0.32	0.37	21.4	18.11

1. Open circuit inductance (OCL) test parameters: 100 kHz, 1.0 Vrms, 0.0 Adc, +25 °C
2. Full load inductance (FLL) test parameters: 100 kHz, 1.0 Vrms, Isat1, , +25 °C
3. Irms1: DC current for an approximate temperature rise of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +155 °C under worst case operating conditions verified in the end application.
4. Irms2: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +155 °C under worst case operating conditions verified in the end application.
5. Isat1: Peak current for approximately 20% rolloff @ +25 °C
6. Isat2: Peak current for approximately 30% rolloff @ +25 °C
7. SRF measured by an Agilent 4395A impedance analyzer
8. K-factor: Used to determine Bp-ac for core loss (see graph). Bp-p = K * L * ΔI. Bp-ac: (Gauss), K: (K-factor from table), L: (Inductance in µH), ΔI (Peak to peak ripple current in Amps).
9. Part Number Definition: MTA2VxxxxX-xxx-R
   MTA= Product code
   2V= Rectangular;
   xxxx= Product size;
   X=Product feature: H= High saturation; L= Low loss; M= High saturation and low loss.
   xxx= Inductance value in µH, R= decimal point, if no R is present last digit indicates number of zeros
   -R = RoHS compliant

Mechanical parameters, pad layout (mm)

MTA2V2722L-2R2-R, MTA2V2722L-3R5-R

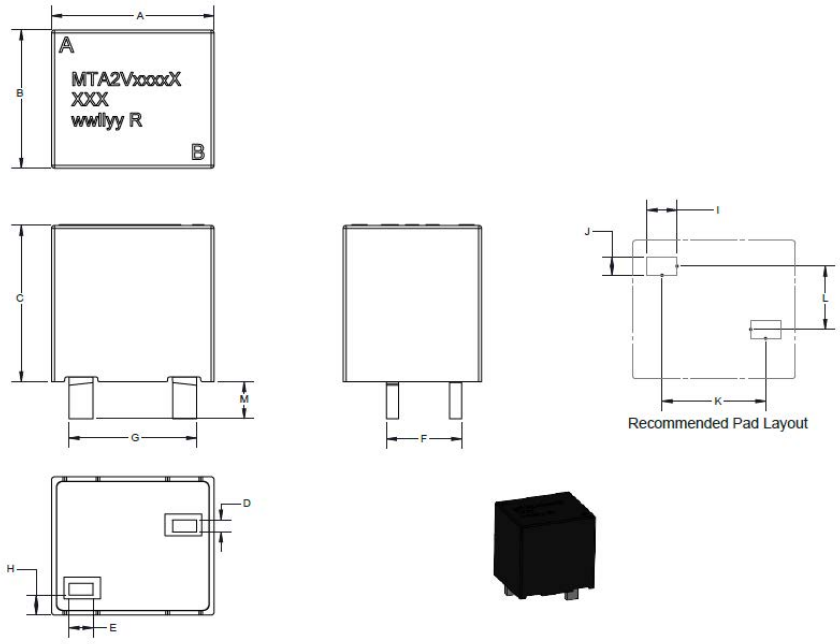


Notes

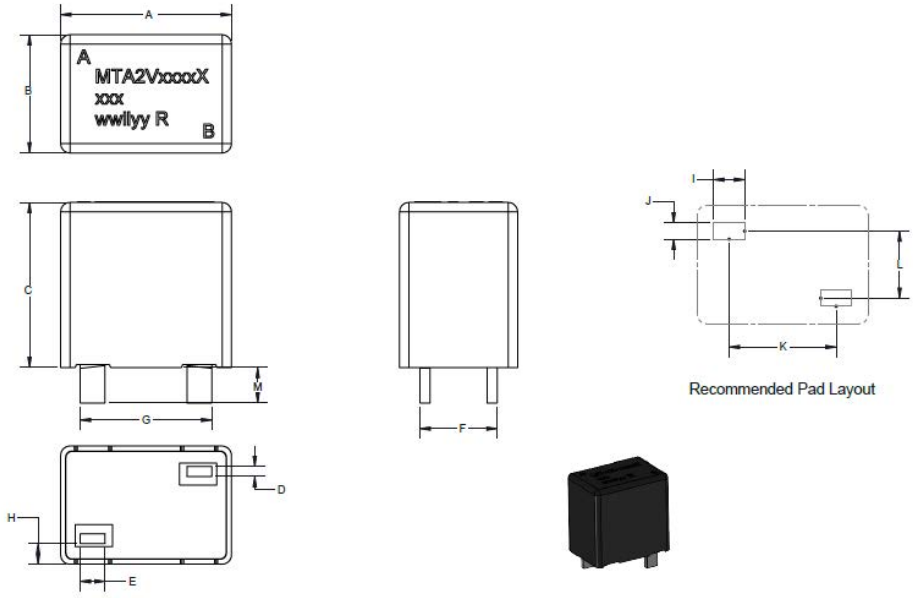
Part marking:
MTA2V=Product code, xxxx= Product size; X= product feature: H= High saturation; L= Low loss; M= High saturation and low loss.
xxx= inductance value in uH, R= decimal point, if no R is present then last digit is the number of zeros,
wwlyy R= Lot code
"A" and "B" is the pin location designator

DCR test points are on the root of pin closed to the core
Traces or vias underneath the inductor is not recommended.

Mechanical parameters, pad layout (mm)
MTA2V2726H-3R3-R, MTA2V2726H-6R8-R, MTA2V2726L-3R3-R, MTA2V2726L-130-R



Mechanical parameters, pad layout (mm)
MTA2V2726M-4R7-R



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xxx= inductance value in uH, R= decimal point, if no R is present then last digit is the number of zeros,
wwllyy R= Lot code
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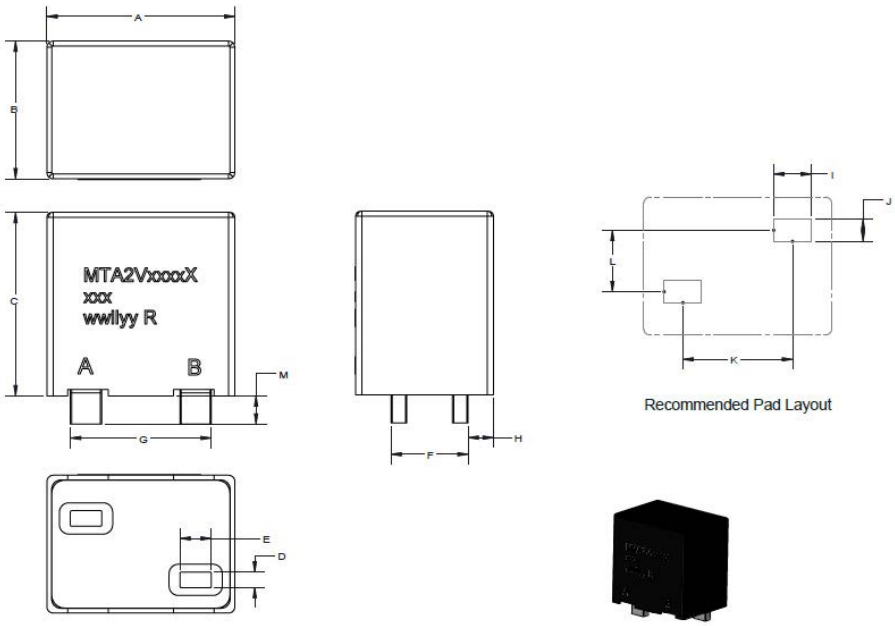
Traces or vias underneath the inductor is not recommended.

Mechanical parameters, pad layout (mm)

MTA2V3029L-2R2-R, MTA2V3029L-3R0-R



Notes

Part marking:
MTA2V=Product code, xxxx= Product size; X= product feature: H= High saturation; L= Low loss; M= High saturation and low loss.
xxx= inductance value in uH, R= decimal point, if no R is present then last digit is the number of zeros,
wwllyy R= Lot code
"A" and "B" is the pin location designator

DCR test points are on the root of pin closed to the core
Traces or vias underneath the inductor is not recommended.

Part number	A ±1.0	B ±1.0	C ±1.0	D ±0.5	E ±0.5	F ±1.0	G ±1.0	H ±1.0	I typical	J typical	K typical	L typical	M ±1.5
MTA2V2722L-xxx-R	26.8	22.8	22.4	1.8	3.0	11.25	16.7	4.15	4.0	2.8	13.7	9.45	4.4
MTA2V2726H-3R3-R	27.0	23.0	26.0	2.0	4.0	12.5	21.2	3.3	5.0	3.0	17.2	10.5	6.5
MTA2V2726H-6R8-R	27.0	23.0	26.0	1.6	4.0	12.4	21.2	3.3	5.0	2.6	17.2	10.8	6.5
MTA2V2726L-3R3-R	27.0	23.0	26.0	2.0	4.0	12.5	21.2	3.3	5.0	3.0	17.2	10.5	6.5
MTA2V2726L-130-R	27.0	23.0	26.0	1.1	4.0	12.3	21.2	3.3	5.0	2.1	17.2	11.2	6.5
MTA2V2726M-4R7-R	27.0	19.0	26.0	1.6	4.0	12.4	21.2	3.3	5.0	2.6	17.2	10.8	6.5
MTA2V3029L-xxx-R	30.0	22.0	29.3	2.5	5.0	12.3	22.5	4.05	6.0	3.5	17.5	9.8	4.4

Packaging information (mm)

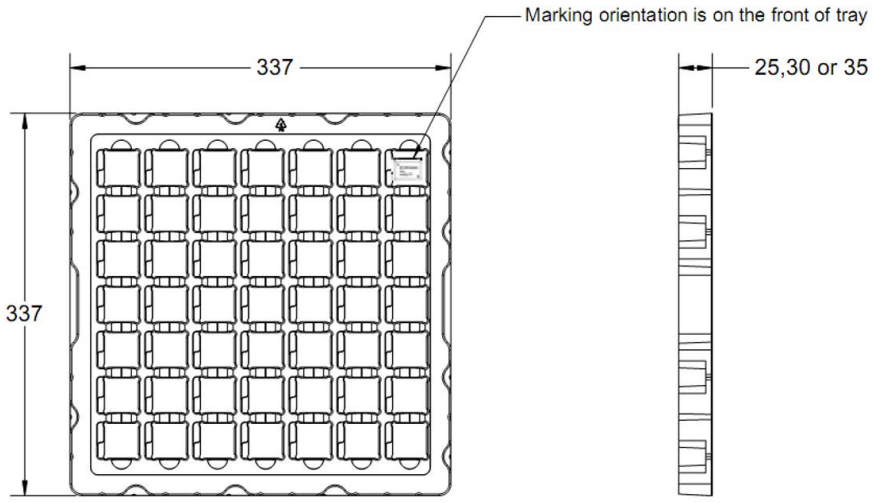
Drawing not to scale

Supplied in tray packaging, place 3 packs of trays in the shipping carton

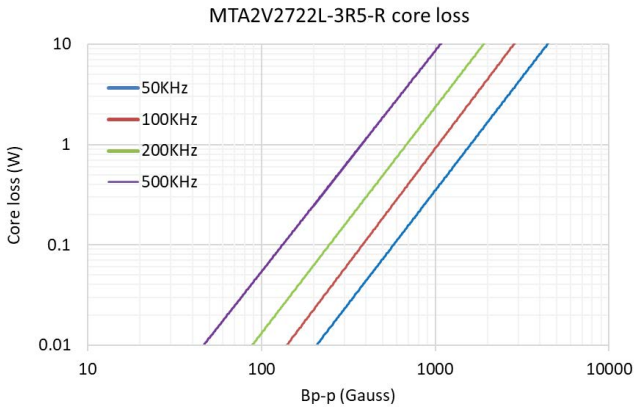
Carton size: 350 x 350 x 140 mm.

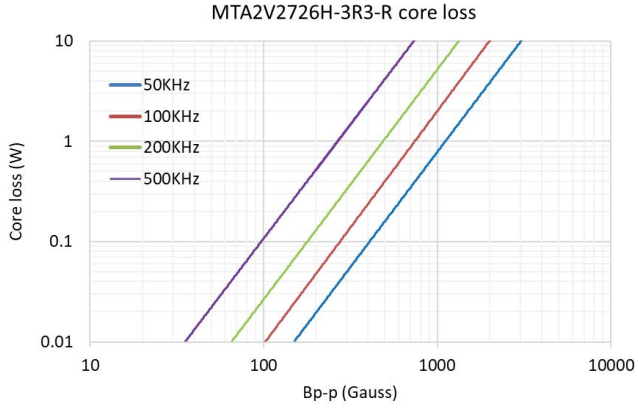
Marking orientation is on the front of tray.

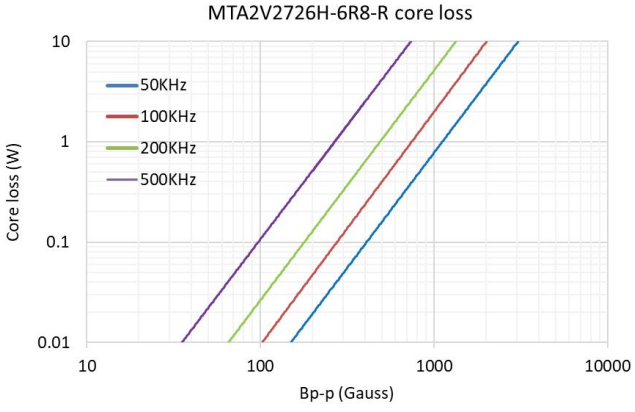
Part number	pcs
MTA2V2722L-2R2-R	63
MTA2V2722L-3R5-R	63
MTA2V2726H-3R3-R	63
MTA2V2726H-6R8-R	63
MTA2V2726L-130-R	63
MTA2V2726L-3R3-R	63
MTA2V2726M-4R7-R	63
MTA2V3029L-2R2-R	49
MTA2V3029L-3R0-R	49



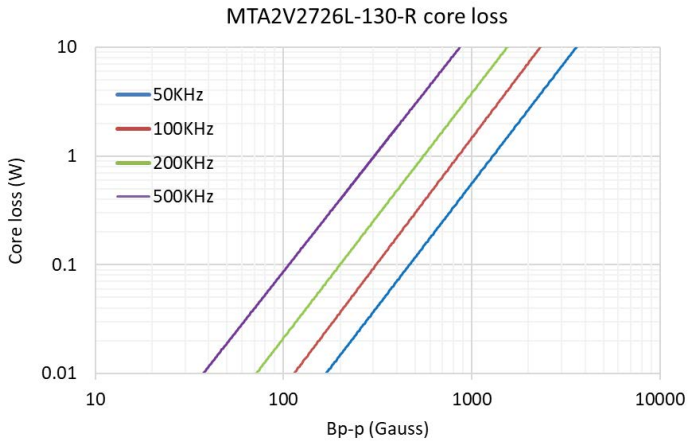
Core loss vs. Bp-p

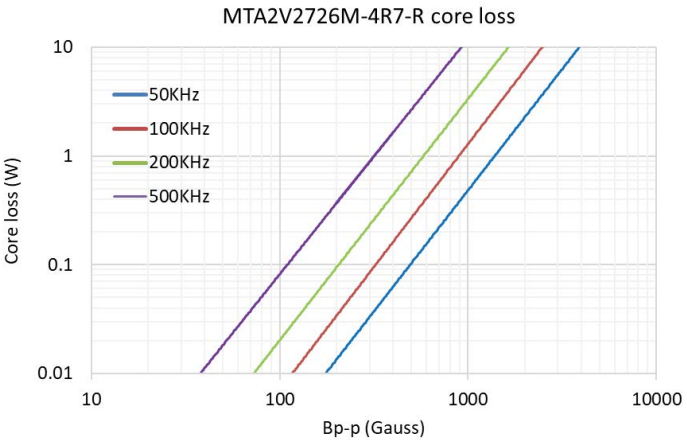


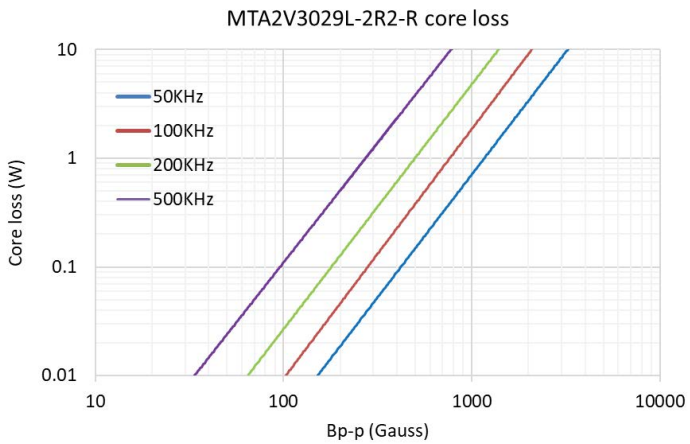




Core loss vs. Bp-p

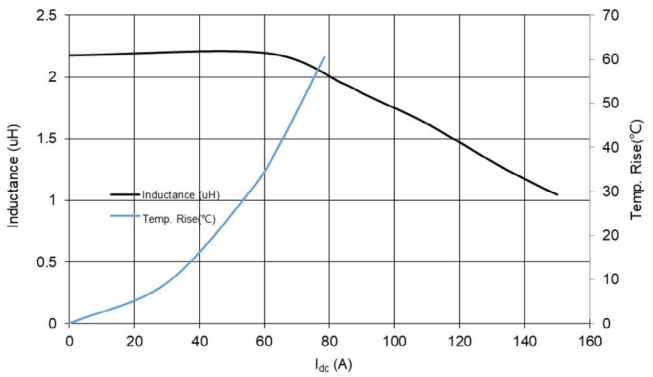






Inductance and temperature rise vs current (+25 °C)

MTA2V2722L-2R2-R



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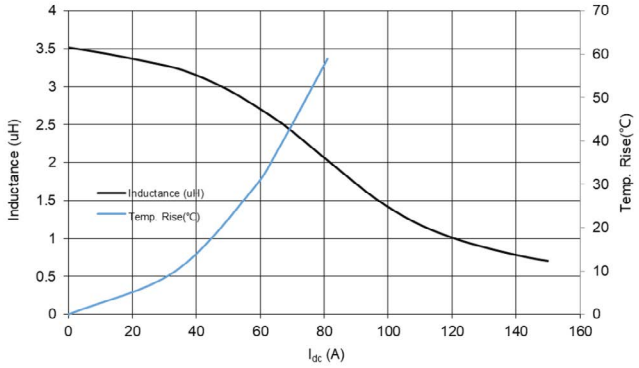
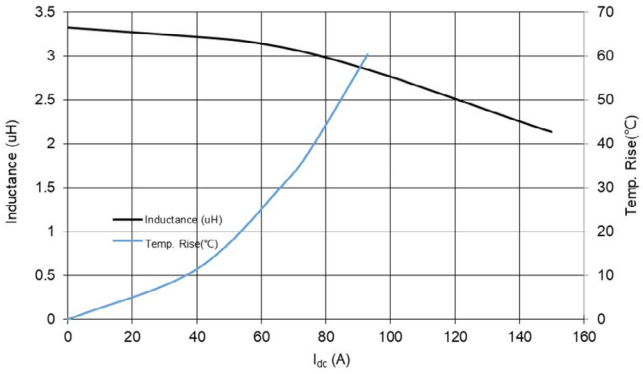
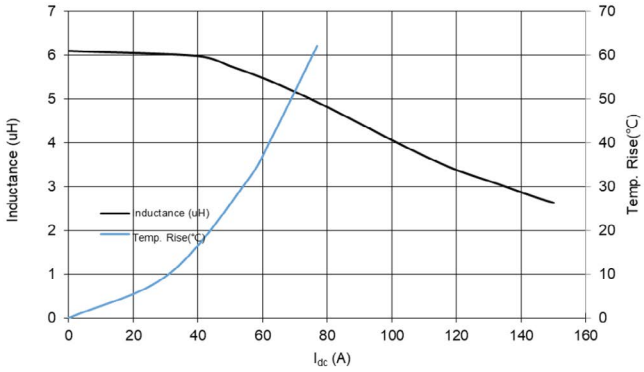


MTA2V2726H-3R3-R



MTA2V2726H-6R8-R



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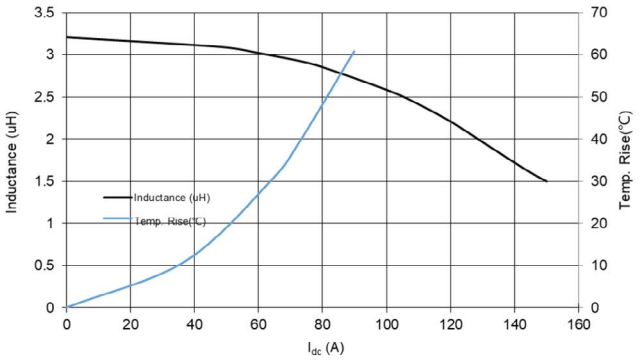
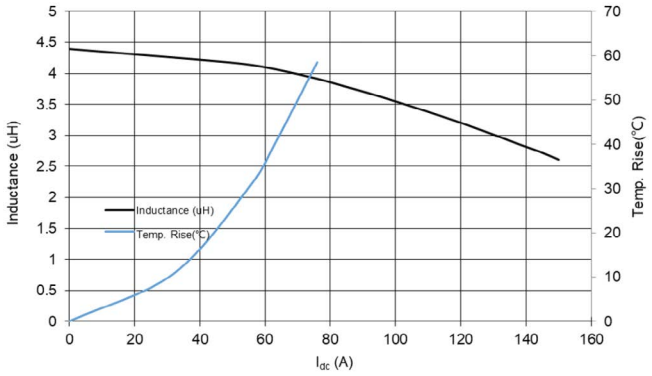
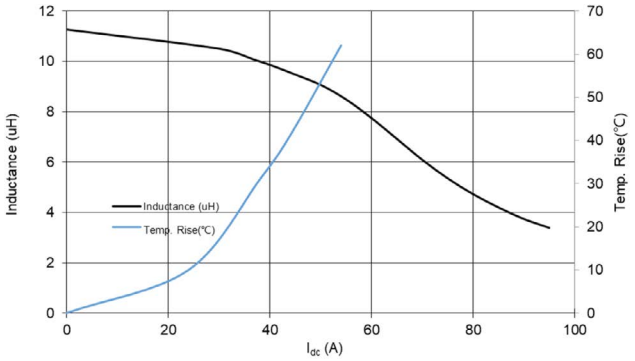


MTA2V2726M-4R7-R



Inductance and temperature rise vs. current (+25 °C)

MTA2V2726L-130-R



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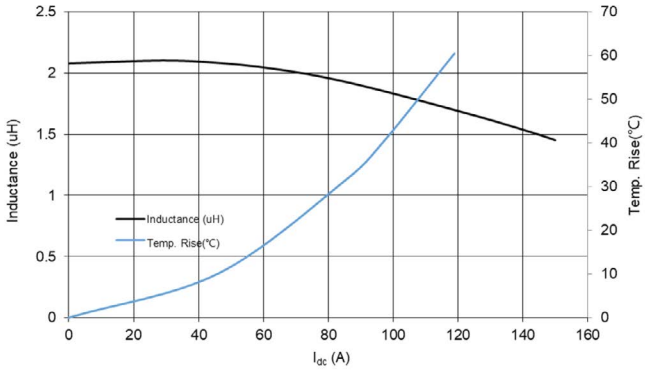

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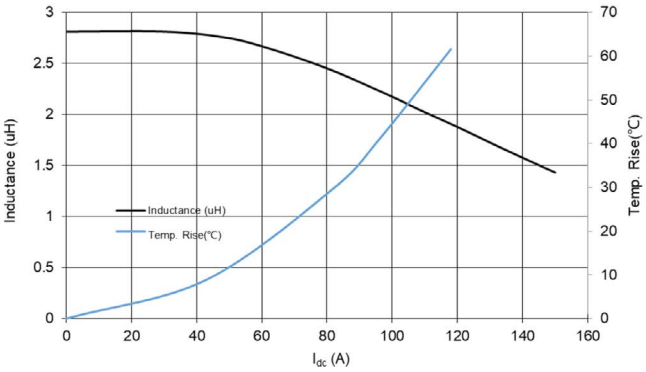
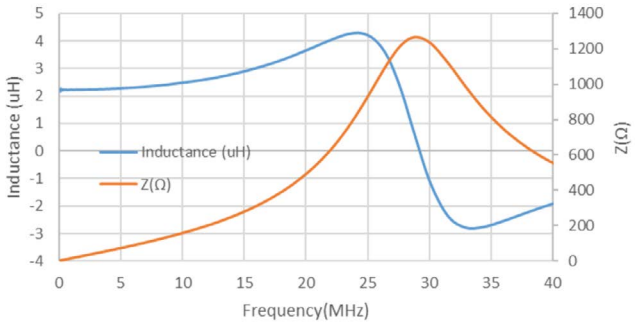
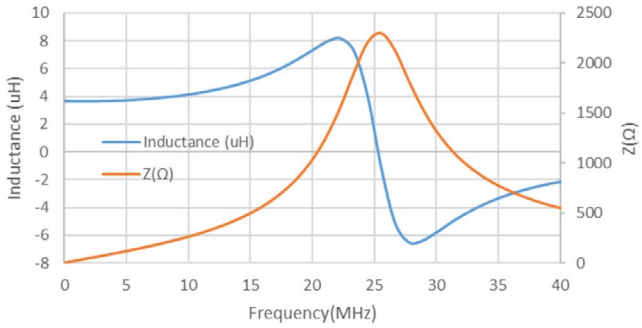


Inductance and impedance (Z) vs. frequency

MTA2V2722L-2R2-R



MTA2V2722L-3R5-R



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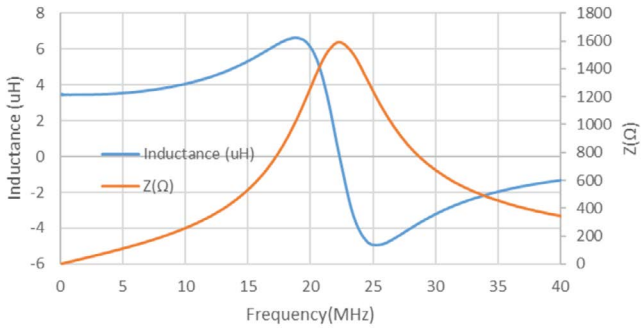
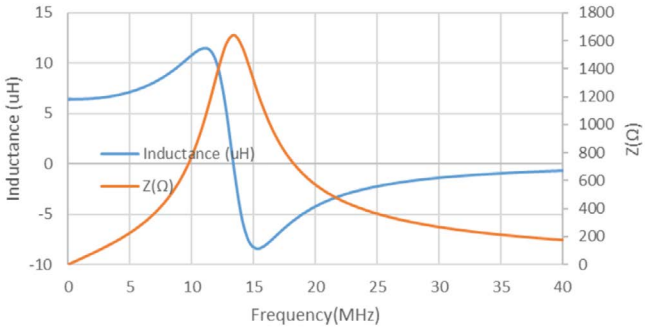
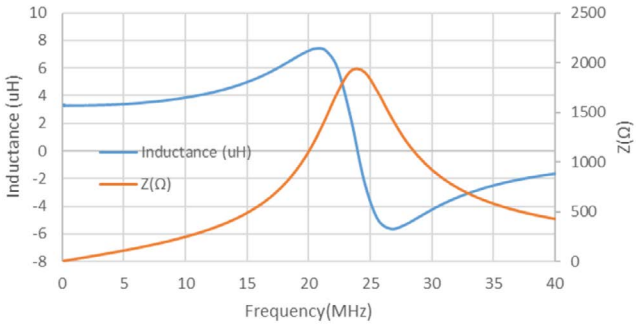


MTA2V2726H-6R8-R



MTA2V2726L-3R3-R



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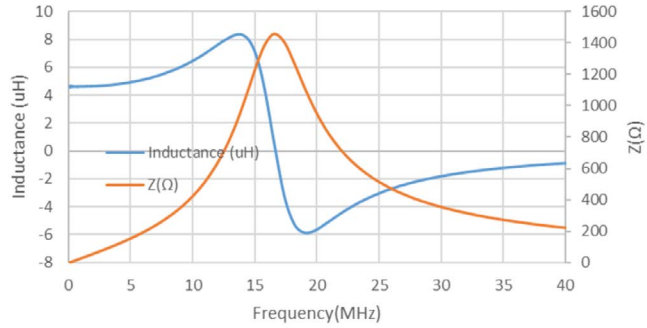
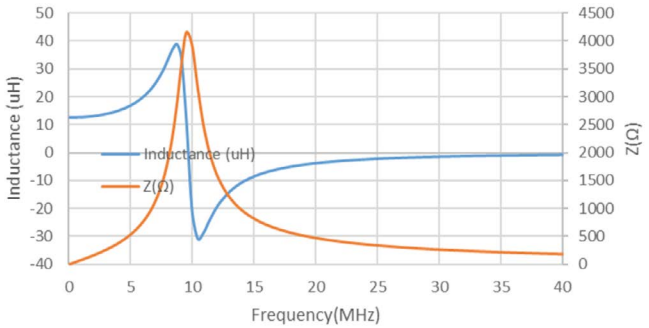
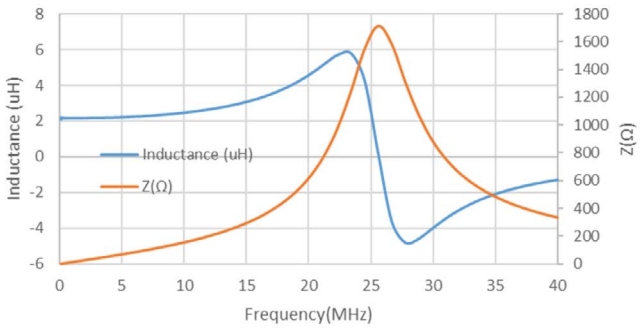


Inductance and impedance (Z) vs. frequency

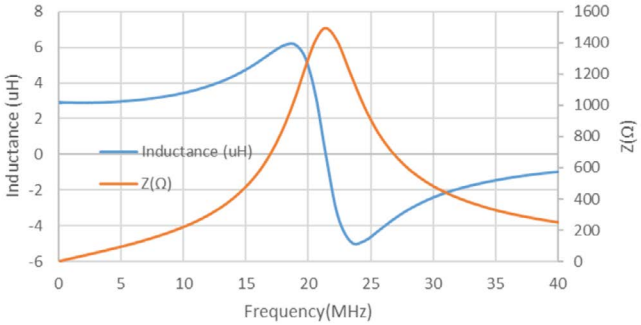
MTA2V2726L-130-R



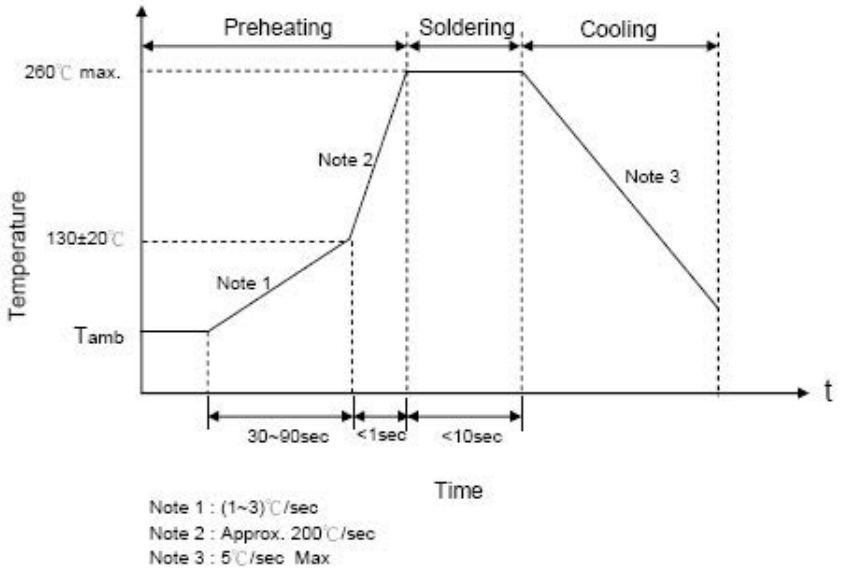
MTA2V3029L-2R2-R



MTA2V3029L-3R0-R



Wave solder profile



Note 1 : (1~3)℃/sec
Note 2 : Approx. 200℃/sec
Note 3 : 5℃/sec Max

Manual solder

+350 °C (+360 °C max), 3-5 seconds. distance from inductor 2 mm minimum, (by soldering iron), generally manual, hand soldering is not recommended.

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